

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Size 12.5 x 12.5 x 8.5 mm

Series/Type: Ordering code: B82477D4

Date: June 2013

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Size 12.5 x 12.5 x 8.5 mm

B82477D4

Rated inductance 2 ... 100µH

Construction

- Ferrite core
- Magnetically shielded
- Winding: enamel copper wire
- Winding soldered to terminals
- Special winding technology for low stray inductance and high coupling factor

Features

- High rated current, low DC resistance
- Temperature range up to +150 °C
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020D
- Qualified to AEC-Q200
- RoHS-compatible
- Coupling factor of typically 99% in average

Applications

- Common mode choke
- DC/DC converters, especially for SEPIC topology
- 1:1 transformer

Terminals

- Base material CuSn6P
- Layer composition Ni, Sn (lead-free)
- Electro-plated

Marking

- Marking on component: Manufacturer, L value (in µH), Date code
- Minimum data on reel: Manufacturer, ordering code, L value, quantity, date of packing

Delivery mode and packing unit

- 24-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 350 pcs./reel

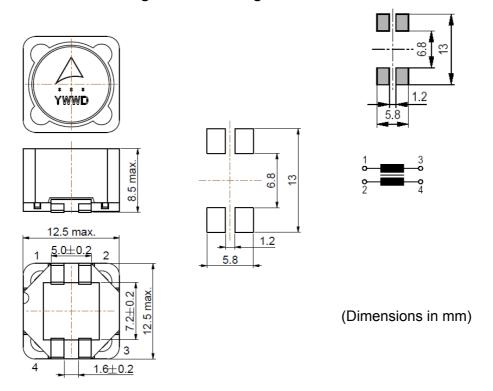




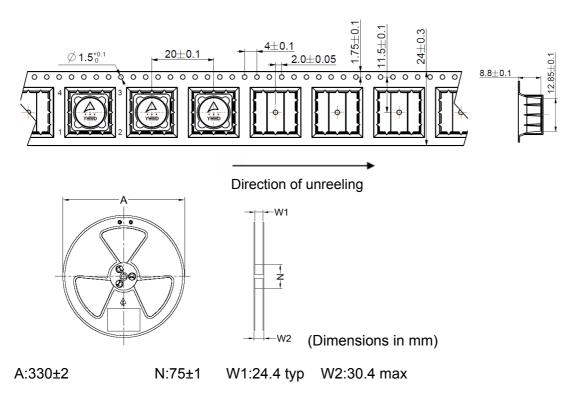
Size 12.5 x 12.5 x 8.5 mm

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Dimensional drawing and circuit diagram



Taping and packing





Size 12.5 x 12.5 x 8.5 mm

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Technical data and measuring conditions

Rated inductance L ₁ , L ₂	Measured with LCR meter Agilent 4284A at frequency f _L , 0.1 V, +20 °C.					
Leakage or stray inductance L _s	Test L ₁₋₃ :(short 2+4) .Measured with LCR meter Agilent 4284A at 100khz, 0.1 V, +20 °C.					
Coupling factor K _{typ}	Coupling in between the 2 windings. $k = \sqrt{1 - \frac{Ls}{Ln}}$					
Operating temperature range	-55°C to +150 °C					
Rated current I _R	Max. permissible DC with temperature increase of ≤ 40 K					
Saturation current I _{Sat}	DC with inductance decrease $\Delta L/L_0$ of approx. 10%					
DC resistance R ₁ ,R ₂ , (max)	Measured at +20 °C					
Solderability (lead-free)	Dip and look method Sn95.5Ag3.8Cu0.7: $+(245 \pm 5)$ °C, (3 ± 0.3) s Wetting of soldering area $\geq 90\%$ (based on IEC 60068-2-58)					
Resistance to soldering heat	+260 °C, 40 s (as referenced in JEDEC J-STD-020D)					
Climatic category	55/150/56 (to IEC 60068-1)					
Storage conditions	Mounted: -55 °C +150 °C Packaged: -25 °C +40 °C, ≤ 75% RH					
Weight	Approx. 4.2 g					



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Characteristics and ordering codes

$L_{1,}L_{2}$	L _{s,typ}	K _{,typ}	Tolerance	f_L	I _{sat,typ}	I _{sat,min}	I _R	$R_{1,} R_{2}/m\Omega$		Ordering code
μΗ	uН	%		MHz	Α	A	Α	max	typ	
2.0	0.20	94.9	±20% ≙	0.1	15	13	5.75	20	16.5	B82477D4202M000
3.0	0.25	95.7			12	10.25	5.50	22	18.1	B82477D4302M000
4.7	0.25	97.3			10	8.75	5.00	26	23.2	B82477D4472M000
6.8	0.25	98.1			8.25	7.25	4.15	35	28.5	B82477D4682M000
10	0.25	98.7			6.50	5.75	3.75	42	35.5	B82477D4103M000
15	0.30	99.0			5.50	4.80	3.25	60	52.5	B82477D4153M000
22	0.30	99.3	M		4.50	4.00	2.80	78	69.5	B82477D4223M000
33	0.35	99.5			3.80	3.30	2.30	110	96.4	B82477D4333M000
47	0.45	99.5			3.30	3.10	1.85	145	115	B82477D4473M000
68	0.50	99.6			2.50	2.30	1.55	215	190	B82477D4683M000
100	0.60	99.7			2.20	2.00	1.35	280	267	B82477D4104M000

Inductance is per winding. When leads are connected in parallel, inductance is the same value. When leads are connected in series, inductance is four times the value.

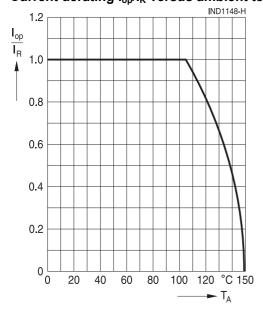
DCR is for each winding. When leads are connected in parallel, DCR is half the value. When leads are connected in series, DCR is twice the value.

Isat ist the current flowing through one winding. When leads are connected in parallel, Isat is the same. When leads are connected in series, Isat is half the value.

I_R is the total current through both windings

 I_1 and I_2 can be calculated like this: $I_1^2 + I_2^2 = I_R^2$

Current derating Iop/IR versus ambient temperature TA





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Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequecy behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
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